

## **SPECIFICATION**

# 宏致電子股份有限公司

桃園縣中壢市東園路13號

No.13, Dongyuan Rd., Jhongli City,

Taoyuan County 320, Taiwan (R.O.C.)

TEL: +886-3-463-2808 FAX: +886-3-463-1800

SPEC. NO.: PS-525		521-XXXXX-XXX	REVISION:	A
PRODUCT N	IAME:	0.8mm PITCH ZIF	BACK-FLIP FFC CONN.	SMT R/A D/C TYPE
PRODUCT N	<b>O</b> :	52521 series		

 SUNYAJIE
 XUZHIYONG
 XUZHIYONG

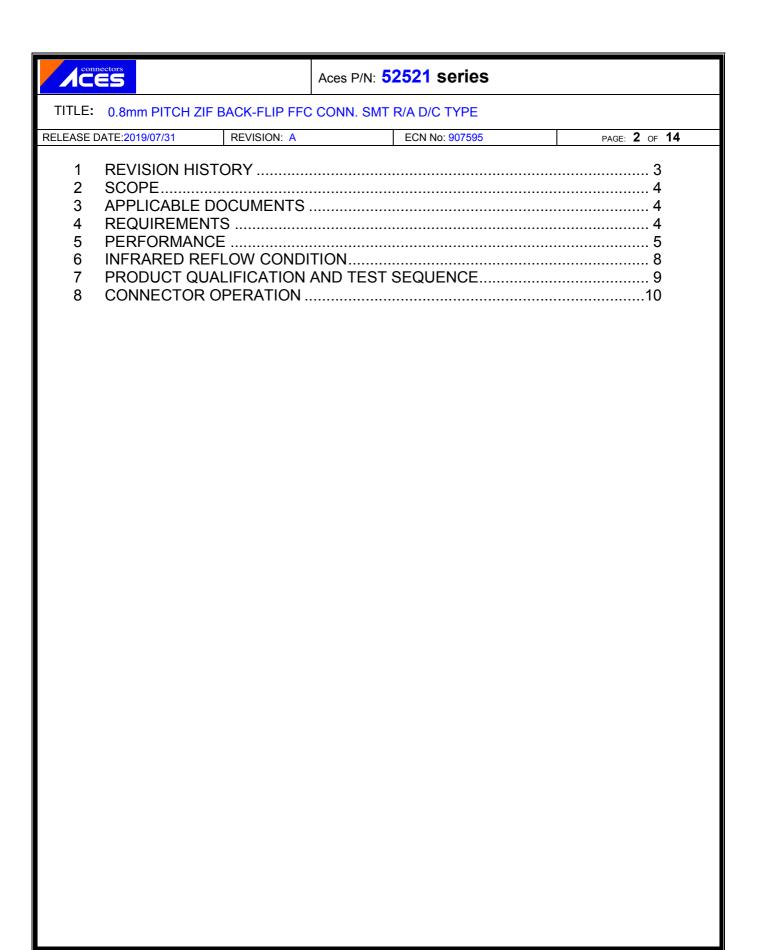
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APPROVED:



TILE: 0.8mm PITCH ZIF BACK-FLIP FFC CONN. SMT R/A D/C TYPE  EASE DATE:2019/07/31 REVISION: A ECN No: 907595 PAGE: 3 OF 14  Revision History  Rev. ECN # Revision Description Prepared Date A ECN-907595 NEW PROJECT SPEC FOR APD1080229 SUNYAJIE 2019/07/31									
Revision History  Rev. ECN # Revision Description Prepared Date	ACES			Aces P/N: 52	2521 series				
Revision History  Rev. ECN # Revision Description Prepared Date	ITLE: 0.8	8mm PITCH ZIF BA	CK-FLIP FFC	CONN. SMT F	R/A D/C TYPE				
Rev. ECN # Revision Description Prepared Date	EASE DATE	:2019/07/31	REVISION: A		ECN No: 907595	PA	GE: <b>3</b> OF <b>14</b>		
Rev. ECN # Revision Description Prepared Date	Revision History								
A ECN- 907595 NEW PROJECT SPEC FOR APD1080229 SUNYAJIE 2019/07/31			F	Revision De	scription	Prepared	Date		
			NEW PROJ	ECT SPEC FO	R APD1080229	SUNYAJIE	2019/07/31		



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#### 2 SCOPE

This specification covers performance, tests and quality requirements for 0.8 mm pitch, ZIF Back-Flip FFC connector. SMT R/A D/C TYPE

#### 3 APPLICABLE DOCUMENTS

EIA-364: ELECTRONICS INDUSTRIES ASSOCIATION

#### 4 REQUIREMENTS

- 4.1 Design and Construction
  - 4.1.1 Product shall be of design, construction and physical dimensions specified on applicable product drawing.
  - 4.1.2 All materials conform to R.o.H.S. and the standard depends on TQ-WI-140101.
- 4.2 Materials and Finish
  - 4.2.1 Contact: High performance copper alloy (Phosphor Bronze)

Finish: (a) Contact Area: Refer to the drawing.

- (b) Under plate: Refer to the drawing.
- (c) Solder area: Refer to the drawing.
- 4.2.2 Housing: Thermoplastic or Thermoplastic High Temp., UL94V-0
- 4.2.3 Actuator: Thermoplastic or Thermoplastic High Temp., UL94V-0
- 4.2.4 Fitting Nail: High performance copper alloy (Brass)

Finish: Refer to the drawing.

- 4.3 Ratings
  - 4.3.1 Working Voltage Less than 36 Volts AC (per pin)
  - 4.3.2 Voltage: 50 Volts AC (per pin)
  - 4.3.3 Current: DC 0.8 Amperes (per pin)
  - 4.3.4 Operating Temperature : -40°C to +85°C



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### 5 Performance

## 5.1. Test Requirements and Procedures Summary

Item	Requirement	Standard					
Examination of Product	Product shall meet requirements of applicable product drawing and specification.	Visual, dimensional and functional per applicable quality inspection plan.					
ELECTRICAL							
Item	Requirement	Standard					
Low Level Contact Resistance	60 m $\Omega$ Max. (initial)per contact 20 m $\Omega$ Max. change allowed	Mate connectors, measure by dry circuit, 20mV Max., 100mA Max. (EIA-364-23)					
Insulation Resistance	500 M Ω Min.	Unmated connectors, apply 500 V DC between adjacent terminals. (EIA-364-21)					
Dielectric Withstanding Voltage	No discharge, flashover or breakdown. Current leakage: 1 mA max.	300 VAC Min. at sea level for 1 minute. Test between adjacent contacts of unmated connectors. (EIA-364-20)					
Temperature Rise	30℃ Max. Change allowed	Mate connector: measure the temperature rise at rated current until temperature stable. The ambient condition is still air at 25°C (EIA-364-70, METHOD1,CONDITION1)					



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MECHANICAL						
Item	Requirement	Standard				
Durability	20 cycles.	The sample should be mounted in the tester and fully mated and unmated the number of cycles specified at the rate of 25.4 ± 3mm/min. (EIA-364-09)				
FPC Retention Force	15 gf/pin MIN.	A connector shall be soldered on a board and insert the actuator, pull the FPC at the speed rate of 25.4 ± 3 mm/min.				
Terminal /Housing Retention Force	50 gf MIN.	Operation Speed:  25.4 ± 3 mm/minute.  Measure the contact retention force with tester.				
Fitting Nail /Housing Retention Force	50 gf MIN.	Operation Speed:  25.4 ± 3 mm/minute.  Measure the contact retention force with tester.				
Vibration	1 μs Max.	The electrical load condition shall be 100 mA maximum for all contacts. Subject to a simple harmonic motion having amplitude of 0.76mm (1.52mm maximum total excursion) in frequency between the limits of 10 and 55 Hz. The entire frequency range, from 10 to 55 Hz and return to 10 Hz, shall be traversed in approximately 1 minute. This motion shall be applied for 2 hours in each of three mutually perpendicular directions. (EIA-364-28 Condition I)				
Shock (Mechanical)	1 μs Max.	Subject mated connectors to 50 G's (peak value) half-sine shock pulses of 11 milliseconds duration. Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen (18 shocks). The electrical load condition shall be 100mA maximum for all contacts. (EIA-364-27, test condition A)				



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ENVIRONMENTAL						
Item	Requirement	Standard				
Resistance to <b>Reflow</b> Soldering Heat	See Product Qualification and Test Sequence Group 10 (Lead Free)	Pre Heat: 150°C~180°C, 60~120sec. Heat: 230°C Min., 40sec Min. Peak Temp.: 260°C Max, 10sec Max. IR reflow cycles: 2 times				
Thermal Shock	See Product Qualification and Test Sequence Group 4	Mate module and subject to follow condition for 5 cycles.				
Humidity	See Product Qualification and Test Sequence Group 4	Mated Connector 40°C, 90~95% RH, 96 hours. (EIA-364-31,Condition A, Method II)				
Temperature Life	See Product Qualification and Test Sequence Group 5	Subject mated connectors to temperature life at 85°C for 96 hours. (EIA-364-17, Test condition A)				
Salt Spray (Only For Gold Plating)	See Product Qualification and Test Sequence Group 6	Subject mated/unmated connectors to 5% salt-solution concentration, 35°C (I) Gold plating 3u" for 48 hours. (EIA-364-26)				
Solder ability	Tin plating: Solder able area shall have minimum of 95% solder coverage. Gold plating: Solder able area shall have minimum of 75% solder coverage	And then into solder bath, Temperature at 245 ±5°C, for 4-5 sec. (EIA-364-52)				
Hand Soldering Temperature Resistance	Appearance: No damage	T≧350°C, 3sec at least.				

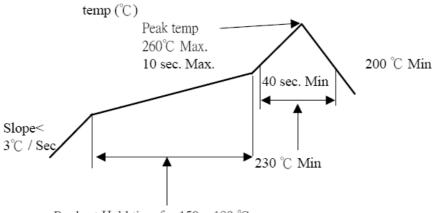
Note. Flowing Mixed Gas shell be conduct by customer request.

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#### 6 INFRARED REFLOW CONDITION

# TEMPERATURE CONDITION GRAPH ( TEMPERATURE ON BOARD PATTERN SIDE )



Pre-heat Hold time for  $150 \sim 180$  °C is  $60 \sim 120$  sec.

connectors
CES

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## 7 PRODUCT QUALIFICATION AND TEST SEQUENCE

	Test Group									
Test or Examination		2	3	4	5	6	7	8	9	10
		Test Sequence								
Examination of Product	1、3	1 ` 6	1 ` 6	1 . 7	1 . 6	1 • 4			1	1
Low Level Contact Resistance		2 ` 5	2 ` 5	2、10	2 . 9	2 ` 5			3	
Insulation Resistance				3 . 9	3 . 8					
Dielectric Withstanding Voltage				4 \ 8	4 · 7					
Temperature Rise	2									
Durability		3								
Vibration			3							
Shock (Mechanical)			4							
Thermal Shock				5						
Humidity				6						
Temperature Life					5					
Salt Spray(Only For Gold Plating)						3				
Solder ability							1			
FPC Retention Force		4								
Terminal / Housing Retention Force								1		
Fitting Nail /Housing Retention Force								2		
Resistance to Soldering Heat									2	
Hand Soldering Temperature Resistance										2
Sample Size	2	4	4	4	4	4	2	4	4	4



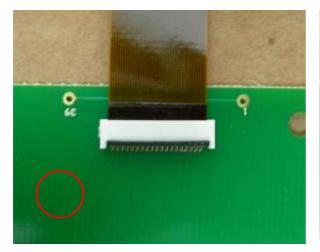
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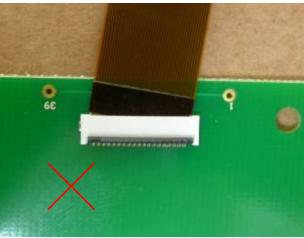
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#### 8 CONNECTOR OPERATION

Exercise care when handling connectors. Follow recommendations given below.

- A. Please open and close the actuator with the connector is mounted on the P.C.Board, and the FPC inserted. The actuator might not come off from the opening and shutting of the actuator in the state that FPC is not inserted and do not do, please.
- B. FPC Correct insertion verification
  A visual comparison of the edge of the housing opening and the FPC pattern boundary will
  prevent diagonal insertion and partial insertion errors.





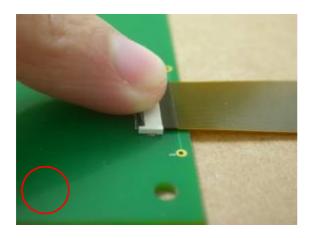


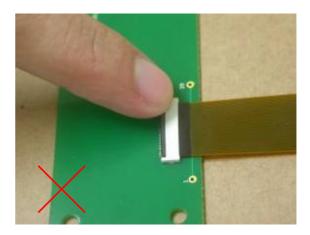
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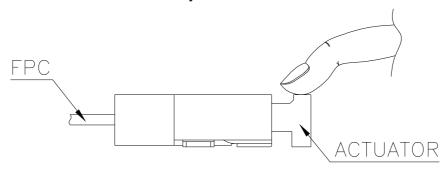
## C. Locking

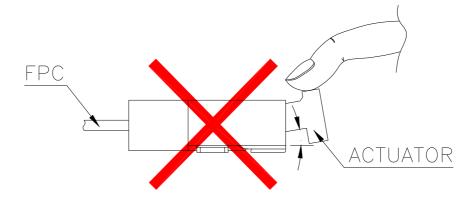
After FPC/FFC insertion, rotate the actuator down to a full stop, pushing it at the center.





About the lock operation When you lock, it is recommended what the actuator does as a whole, and the actuator was shut surely.





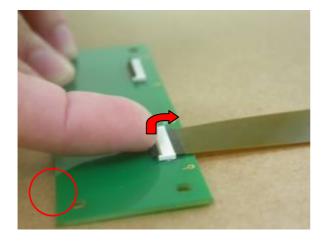


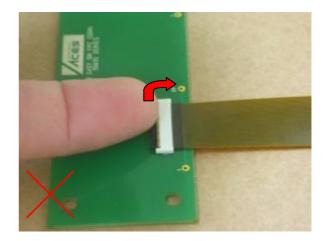
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#### D. Lock release

Carefully rotate the actuator up to 90°, lifting it at the center.





• The actuator opens by rotating it in the direction OPPOSITE to the direction of the insertion of the FPC. DO NOT attempt to open it from the same side as the insertion of the FPC.

